

## **CALL FOR SPONSORSHIP/EXHIBITORS**

## The 17<sup>th</sup> International Conference on Magnetic Resonance Microscopy (ICMRM 2023)

The aim of the International Conference on Magnetic Resonance Microscopy (ICMRM) is to promote recent advancements in high-resolution, spatially resolved magnetic resonance methods and applications. The first ICMRM was held in 1991 in Heidelberg and was originally known as the "Heidelberg Conference". Currently, ICMRM is organized biannually by the Division of Spatially Resolved Magnetic Resonance of the AMPERE Society.

The 17<sup>th</sup> ICMRM will be held from 27-31 Aug. 2023 in Singapore, fully physical. The official website can be found at http://icmrm2023.sciencesconf.org/. The Organizing Committee would like to invite your organization to support this event. The sponsors and exhibitors will have opportunities to interact with academic researchers, industrial developers, and top-notch postgraduate students in research fields. Your participation will increase your organization's visibility in the magnetic resonance microscopy community and also help the conference organizers to provide a more exciting program.

	PLATINUM USD 5,000	GOLD USD 2,000	Silver USD 1,000	Bronze USD 500
Logo acknowledgement on the conference website with a corporate link	x	x	x	x
Logo acknowledgement on the cover of the e-Program Brochure & e-Proceedings, if available	x	x	x	x
Logo acknowledgement on the conference banners and conference backdrop, if available	x	x	x	x
Your company logo on the main screen at the beginning of all plenary sessions acknowledging your Sponsor Status	x	x	x	x
Full page colour advertisement in the conference handbook (sponsor to provide artwork)	x			
Opportunity to give a 20-minute industrial talk. Content of the presentation is subject to approval by the Technical Program Committee	x			
Complimentary conference registrations	2	1	0	0
Special mention during opening and closing sessions	x			
One exhibition booth (1.5 m x 1.5 m, with a table, one poster stand)	Double	Double	Single	No

The sponsorship/exhibitor packages are available for your considerations below.

Please contact the conference co-Chairs through Email.

Sincerely,

Robin Dykstra, robin.dykstra@vuw.ac.nz

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